R263-Z30 (rev. AAC2) | (rev.AAC1) | (rev.AAH2) | (rev.AAH1)

Rack Server - AMD EPYC™ 9004 - 2U UP 12-Bay Gen4 NVMe/SATA/SAS | Application: Networking & Hybrid

Server

AMD EPYC™ 9004 Series processors

AMD EPYC™ 9004 Series processors with AMD 3D V-Cache™ Technology

Single processor, 5nm technology

12-Channel RDIMM DDR5, 12 x DIMMs

Dual ROM Architecture

- 1 x 1Gb/s LAN port (Intel® I210-AT)
- 1 x Dedicated management port
- 4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS hot-swappable bays
- 8 x 3.5"/2.5" SATA/SAS hot-swappable bays
- 1 x M.2 slot with PCle Gen3 x4 interface
- 2 x FHHL PCIe Gen5 x16 slots
- 3 x FHHL PCIe Gen4 x16 and x8 slots
- 2 x OCP 3.0 Gen5 x16 slots
- 1+1 1300W 80 PLUS Platinum redundant power supplies









OVERVIEW SPECIFICATIONS SUPPORT RESOURCES BUY

R263-Z30 (rev. AAC2)

Dimensions (WxHxD, mm)

2U 438 x 87.5 x 710

Motherboard

MZ33-DC0

CPU

AMD EPYC™ 9004 Series processors
AMD EPYC™ 9004 Series processors with AMD 3D V-Cache™
Technology
Single processor, 5nm technology
*Up to 128-core, 256 threads per processor
cTDP up to 300W at ambient 35°C

*cTDP supported up to 400W under limited thermal conditions. Please contact technical support for more details.

Socket

1 x LGA 6096 Socket SP5

Chipset

System on Chip

Memory

12 x DIMM slots DDR5 memory supported only 12-Channel memory architecture RDIMM modules up to 96GB supported 3DS RDIMM modules up to 256GB supported Memory speed: Up to 4800 MHz

LAN

Rear sic

1 x 1Gb/s LAN port (1 x Intel® I210-AT) Supports NCSI function

1 x 10/100/1000 management LAN

Video

Integrated in Aspeed® AST2600 2D Video Graphic Adapter with PCIe bus interface 1920x1200@60Hz 32bpp, DDR4 SDRAM

Storage

Front side:

4 x 3.5"/2.5" Gen4 NVMe/SATA/SAS hot-swappable bays 8 x 3.5"/2.5" SATA/SAS hot-swappable bays

SAS card is required for SAS devices support

SAS

Depends on SAS add-in card

RAID

N/A

Expansion Slots

Riser Card CRS201H:

- 1 x PCle x16 (Gen5 x16) FHHL slot
- 1 x PCle x16 (Gen4 x16) FHHL slot

Riser Card CRS201M:

- 1 x PCle x16 (Gen5 x16) FHHL slot
- 2 x PCIe x16 (Gen4 x8) FHHL slots
- 2 x OCP 3.0 slots with PCIe Gen5 x16 bandwidth Support NCSI function
- 1 x M.2 slot:
- M-key
- PCle Gen3 x4
- Supports 2280/22110 cards

Internal I/O

1 x TPM header

Front I/O

- 2 x USB 3.2 Gen1
- 1 x Power button with LED
- 1 x ID button with LED
- 1 x NMI button
- 1 x Reset button
- 2 x LAN activity LEDs (1 x LED disabled)
- 1 x Storage activity LED
- 1 x System status LED

Rear I/O

2 x USB 3.2 Gen1 1 x Mini-DP 1 x RJ45 1 x MLAN 1 x ID button with LED

В.....

Speed and bandwidth:
PCIe Gen4 x4 or SATA 6Gb/s or SAS 12Gb/s

TPM

1 x TPM header with SPI interface Optional TPM2.0 kit: CTM010

Power Supply

1+1 1300W 80 PLUS Platinum redundant power supplies

AC Input:

- 100-240V~/ 12-7A, 50-60Hz
- 200-240V~/ 8A, 50-60Hz

DC Input:

- 240Vdc/ 6.5A

DC Output:

- Max 1000W/ 100-240V~
- + 12V/ 80.5A
- + 12Vsb/ 3A
- Max 1300W/ 200-240V~ or 240Vdc Input
- + 12V/ 105.4A
- + 12Vsb/ 3A

Note: The default power supply is based on a basic system configuration. Please contact with technical representatives to determine the best power supply selection for your system configuration requirements and preferred efficiency.

System Management

Aspeed® AST2600 management controller
GIGABYTE Management Console (AMI MegaRAC SP-X) web interface

Dashboard

HTML5 KVM

Sensor Monitor (Voltage, RPM, Temperature, CPU

Sensor Reading History Data

FRU Information

SEL Log in Linear Storage / Circular Storage Policy

Hardware Inventory

Fan Profile

System Firewall

Power Consumption

Power Control

Advanced power capping

LDAP / AD / RADIUS Support

Backup & Restore Configuration

Remote BIOS/BMC/CPLD Update

Event Log Filter

User Management

Media Redirection Settings

PAM Order Settings

SSL Settings

SMTP Settings

OS Compatibility

Please refer to OS compatibility table in support page

System Fans

4 x 80x80x38mm (18,300rpm)

Operating Properties

Operating temperature: 10°C to 35°C

Operating humidity: 8%-80% (non-condensing)

Non-operating temperature: -40°C to 60°C

Non-operating humidity: 20%-95% (non-condensing)

Packaging Dimensions

989 x 594 x 279 mm

Packaging Content

1 x R263-Z30

1 x CPU heatsink

1 x Mini-DP to D-Sub cable

1 x 2-Section Rail kit